



TFW 2827

**REVOCATION AND POWER OF ATTORNEY, CHANGE OF  
CORRESPONDENCE ADDRESS, APPOINTMENT OF NEW POWER OF  
ATTORNEY AND STATEMENT UNDER 37 CFR 3.73(B)**

I hereby revoke all previous powers of attorney given in the U.S. Patent 6630725.

  X   I hereby appoint the practitioners associated with Customer Number 23125.

**CHANGE OF CORRESPONDENCE ADDRESS**

Please change the correspondence address for the above-identified U.S. patent to the address associated with Customer Number 23125.

I am the:

           Applicant/Inventor  
  X   Assignee of the entire interest. See 37 CFR 3.71.  
(Statement under 37 CFR 3.73(b) is below).

**STATEMENT UNDER 37 CFR 3.73(b)**

Freescale Semiconductor, Inc., a Delaware Corporation states that it is the Assignee of the entire right, title and interest in the patent application/patent identified above by virtue of a chain of title from the Inventor(s), of the patent identified above, to Freescale Semiconductor, Inc. which was recorded in the United States Patent and Trademark Office at the reel and frame numbers listed on the attached document.

The undersigned, whose title is supplied below, is authorized to act on behalf of the Assignee.

Date: May 25, 2006

SIGNATURE of Assignee:

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## Assignments on the Web &gt; Patent Query

## Patent Assignment Abstract of Title

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## Total Assignments: 2

**Patent #:** 6630725    **Issue Dt:** 10/07/2003    **Application #:** 09684576    **Filing Dt:** 10/06/2000**Inventors:** Shun-Meen Kuo, Darrel R. Frear**Title:** ELECTRONIC COMPONENT AND METHOD OF MANUFACTURE

## Assignment: 1

**Reel/Frame:** 011285/0390**Recorded:** 10/06/2000**Pages:** 3**Conveyance:** ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).**Assignors:** KUO, SHUN-MEEN**Exec Dt:** 10/03/2000FREAR, DARREL R.**Exec Dt:** 10/03/2000**Assignee:** MOTOROLA, INC.INTELLECTUAL PROPERTY DEPT.  
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## Assignment: 2

**Reel/Frame:** 015698/0657**Recorded:** 05/07/2004**Pages:** 189**Conveyance:** ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).**Assignor:** MOTOROLA, INC.**Exec Dt:** 04/04/2004**Assignee:** FREESCALE SEMICONDUCTOR, INC.6501 WILLIAM CANNON DRIVE WEST  
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